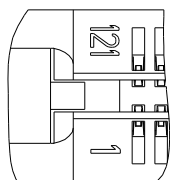
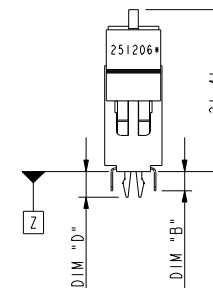
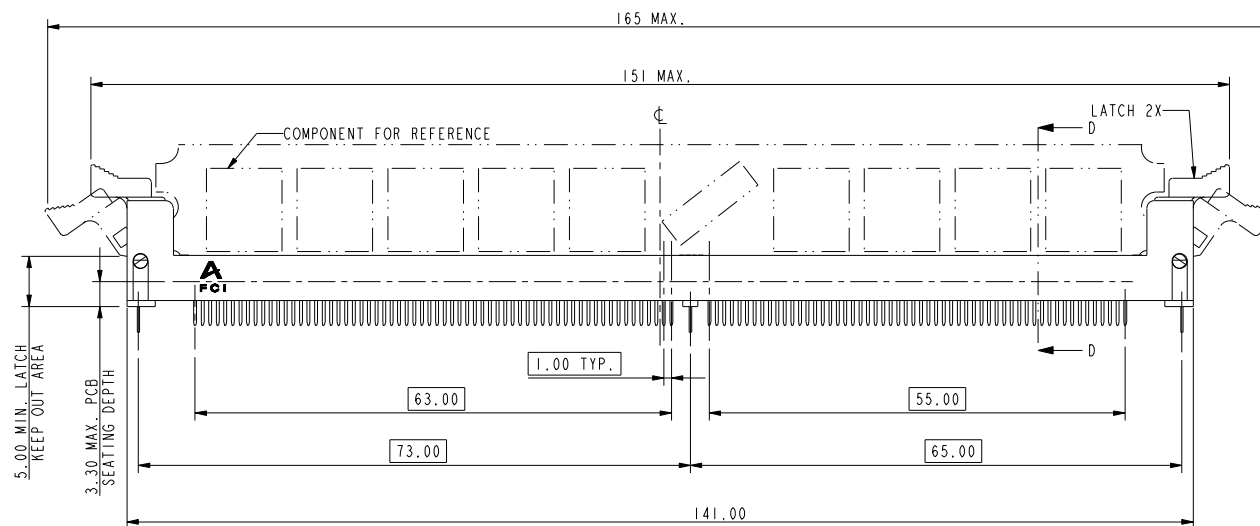
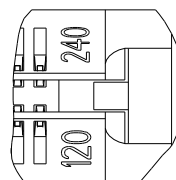


SECTION D-D

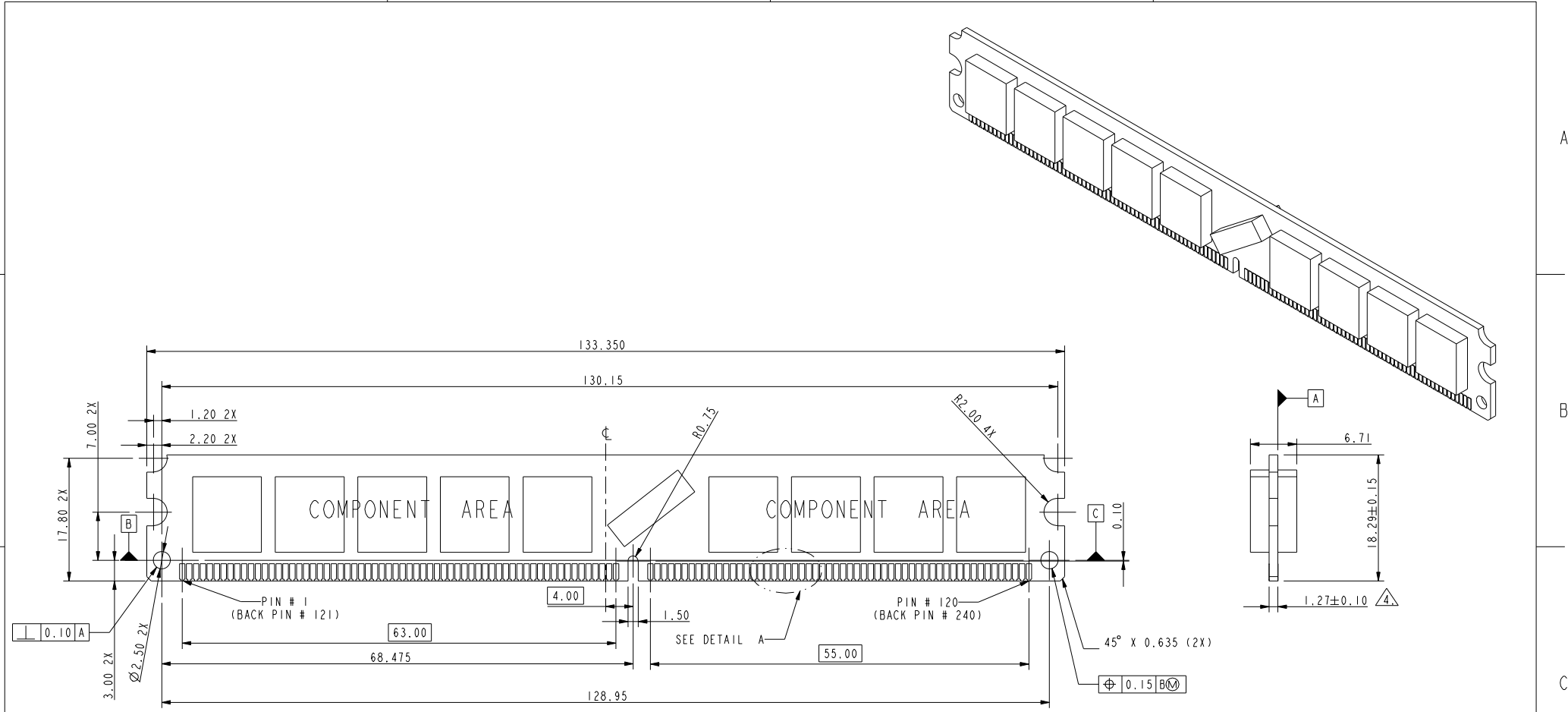


DETAIL A
SCALE 3.000

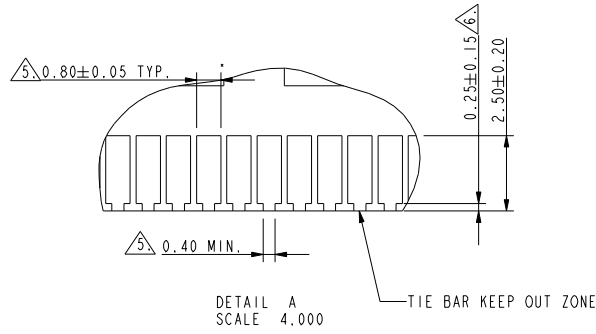


DETAIL B
SCALE 3.000

Mark with WITH_OPEN_LATCH REV. E in area indicated by X.....				Material *			Spec ref 		tolerance		projection			
				Mat code										
				Heattreat										
				Plating/Finish										
rev	ecn no	dr	date	Dr	RICHARD CHIU		01/11/05	size A4			Scale 1,000			
A	DG06-0047	WK	02/13/06	Eng	RICHARD CHIU		01/11/05						Product family	
B	DG06-0093	CS	03/06/06	Chr	PAUL WANG		01/11/05	Model Name WITH_OPEN_LATCH			ECN		DG06-0506	
C	DG06-0506	CS	12/05/06	Appr	JOSEPH HSIA		01/11/05	Model Revision			I	REL Level	RELEASED	
D	DG06-0547	CS	12/21/06			title DDR11 VERY LOW PROFILE SOCKET ASSEMBLY			dwg no 10052286		Rev. E			
E	DG07-0194	CS	15/05/07											
				Pro/E file		catalog		PDM: Rev: E		CUSTOMER		sheet 1 of 4		



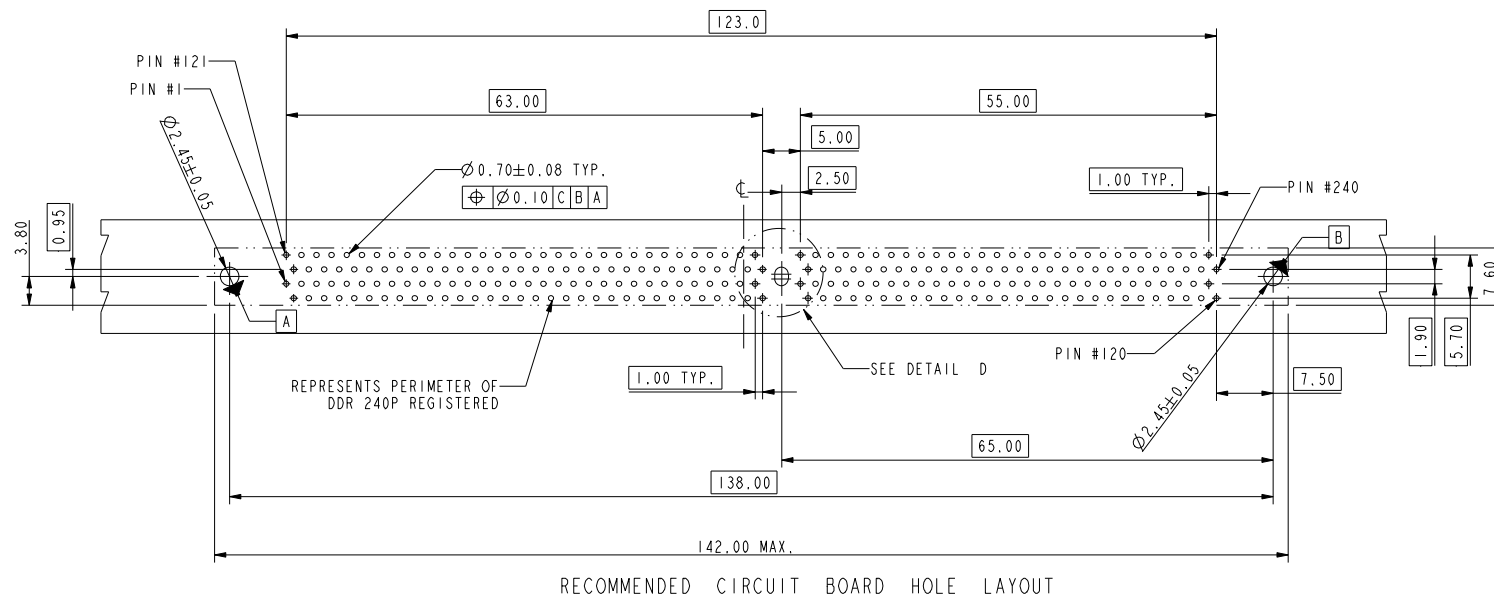
RECOMMENDED MODULE LAYOUT (PER JEDEC MO-XXX)



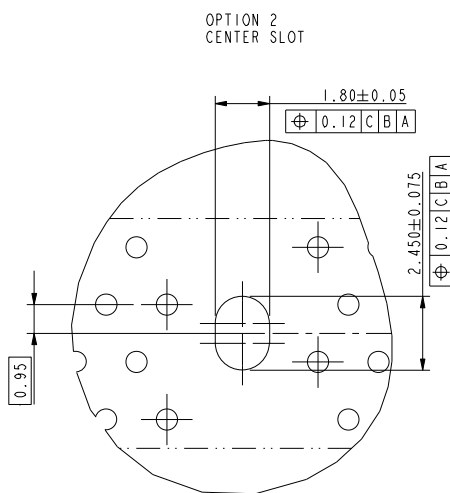
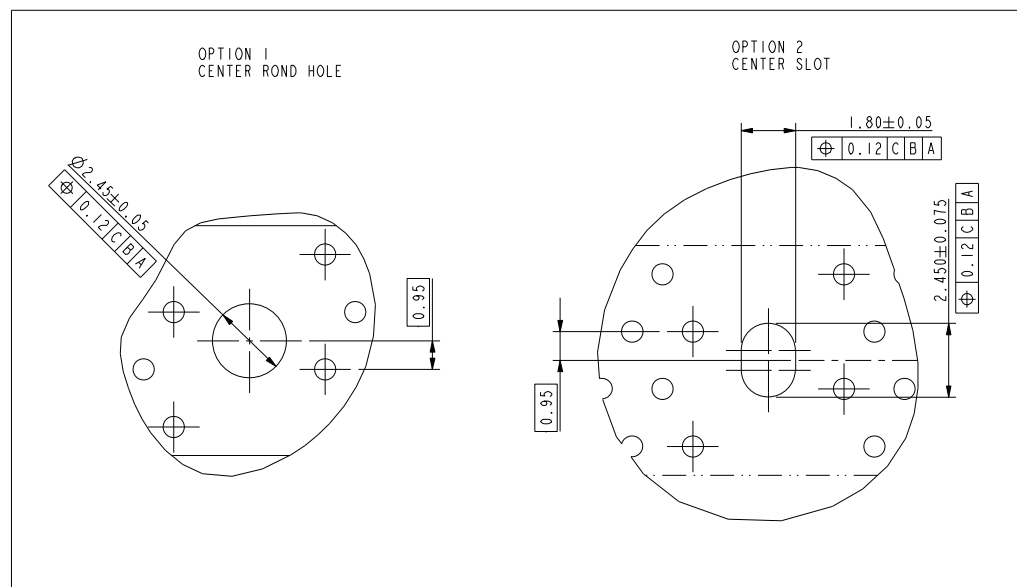
tolerances unless otherwise specified		
linear	.X	±0.38
	.XX	±0.25
	.XXX	±0.13
angles	X°	±2°

	title DDR11 VERY LOW PROFILE SOCKET ASSEMBLY	dwg no 10052286	Rev. E
	Pro/E file catalog	STATUS PDM: Rev:E	CUSTOMER sheet 2 of 4

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DETAIL D
SCALE 4,000



tolerances unless otherwise specified		
linear	.X	± 0.38
	.XX	± 0.25
	.XXX	± 0.13
angles	$^{\circ}$	$\pm 2^{\circ}$

	title		dwg no	10052286	Rev. E
	DDR II VERY LOW PROFILE SOCKET ASSEMBLY				
Pro/E file	catalog	CUSTOMER			sheet 3 of 4

PDM: Rev: E

STATUS: Released

Printed: Jul 28 20



NOTES:

1. MATERIAL:
HOUSING: HIGH PERFORMANCE RESINS, GLASS FILLED UL94V-0 RATED.
EJECTOR: HIGH PERFORMANCE RESINS, GLASS FILLED UL94V-0 RATED.
TERMINAL: PHOSPHOR BRONZE.
METAL CLIP: COPPER ALLOY.
2. FCI LOGO TO BE APPROXIMATELY LOCATED AS SHOWN ON PRINT.
3. PRODUCT SPECIFICATION: GS-12-352.
4. CARD THICKNESS APPLIES ACROSS TABS AND INCLUDES PLATING AND/OR METALIZATION.
5. LEADING EDGE OF CONTACT PADS SPECIFIED BY THE KEEP OUT ZONE SHALL BE FREE OF BURRS AND EXTERNAL TIE BARS.
FOR OPTIMUM PERFORMANCE, THE TIE BAR IS TO BE ON AN INTERNAL LAYER SO THAT THE REMNANT CANNOT CAUSE CONTACT DAMAGE.
6. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
7. THE HOUSING WILL WITH STAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION.
8. DATE CODE: XXXXXX* MEANS MONTH/DAY/YEAR.
"*" MEANS PRODUCTION LINE CODE.

10052286-□□□□□

STYLE : MECHAMICAL KEYING

- 1 : 1.8 VOLT. W/TYPE "C"
2 : 2.5 VOLT. W/TYPE "L"
3 : X.X VOLT. W/TYPE "R"

METAL CLIP

- 1 : WITH METAL CLIP + DIM."D"=3.05
2 : WITH METAL CLIP + DIM."D"=3.56
3 : WITH METAL CLIP + DIM."D"=3.43

TAIL LENGTH

CODE	DIM. "B"	PCB THICKNESS
0	2.54	1.47 mm (0.058")
1	2.67	1.60 mm (0.063")
2	3.18	2.36 mm (0.093")
3	4.00	3.18 mm (0.125")

PLATING

CODE	CONTACT	SOLDERTAIL	UNDERPLATE
2	15 u"(0.38um) MIN. GOLD	100u"(2.54um) MIN. TIN/LEAD	50u"(1.27um) MIN. NICKEL OVERALL
3	30u"(0.76um) MIN. GOLD		
4	3u"(0.076um) MIN. GOLD		
7LF	15u"(0.38um) MIN. GOLD	100u"(2.54um) MIN. 100% TIN	50u"(1.27um) MIN. NICKEL OVERALL
8LF	30u"(0.76um) MIN. GOLD		
9LF	3u"(0.076um) MIN. GOLD		

COLOR OF HOUSING AND EJECTOR

- 0 : BLACK HOUSING + IVORY EJECTOR
1 : BLUE HOUSING + IVORY EJECTOR
2 : BLACK HOUSING + BLACK EJECTOR

	title DDR II VERY LOW PROFILE SOCKET ASSEMBLY	dwg no 10052286	Rev. E
Pro/E file	catalog	CUSTOMER	

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STATUS: Released

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